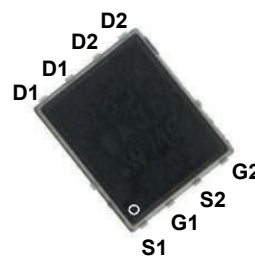
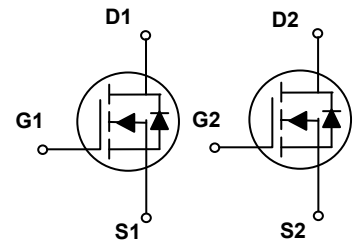


### Main Product Characteristics

|               |                    |
|---------------|--------------------|
| $V_{(BR)DSS}$ | 100V               |
| $R_{DS(ON)}$  | 34m $\Omega$ (Max) |
| $I_D$         | 20A                |



PPAK5x6



Schematic Diagram

### Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



### Description

The GSFP34010 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supplies and a wide variety of other applications.

### Absolute Maximum Ratings ( $T_J=25^{\circ}\text{C}$ unless otherwise specified)

| Parameter                                                                           | Symbol          | Parameter   | Unit                 |
|-------------------------------------------------------------------------------------|-----------------|-------------|----------------------|
| Drain-Source Voltage                                                                | $V_{DS}$        | 100         | V                    |
| Gate-to-Source Voltage                                                              | $V_{GS}$        | $\pm 20$    | V                    |
| Continuous Drain Current, @ Steady-State ( $T_C=25^{\circ}\text{C}$ ) <sup>1</sup>  | $I_D$           | 20          | A                    |
| Continuous Drain Current, @ Steady-State ( $T_C=100^{\circ}\text{C}$ ) <sup>1</sup> |                 | 18          | A                    |
| Pulsed Drain Current ( $T_C=25^{\circ}\text{C}$ ) <sup>2</sup>                      | $I_{DM}$        | 80          | A                    |
| Power Dissipation ( $T_C=25^{\circ}\text{C}$ ) <sup>3</sup>                         | $P_D$           | 19          | W                    |
| Single Pulse Avalanche Energy                                                       | $E_{AS}$        | 9.8         | mJ                   |
| Single Pulse Avalanche Current                                                      | $I_{AS}$        | 14          | A                    |
| Junction-to-Ambient (PCB Mounted, Steady-State)                                     | $R_{\theta JA}$ | 62          | $^{\circ}\text{C/W}$ |
| Junction-to-Case                                                                    | $R_{\theta JC}$ | 6.58        | $^{\circ}\text{C/W}$ |
| Operating Junction and Storage Temperature Range                                    | $T_J/T_{STG}$   | -55 to +150 | $^{\circ}\text{C}$   |
| Soldering Temperature (SMD)                                                         | $T_{sold}$      | 260         | $^{\circ}\text{C}$   |

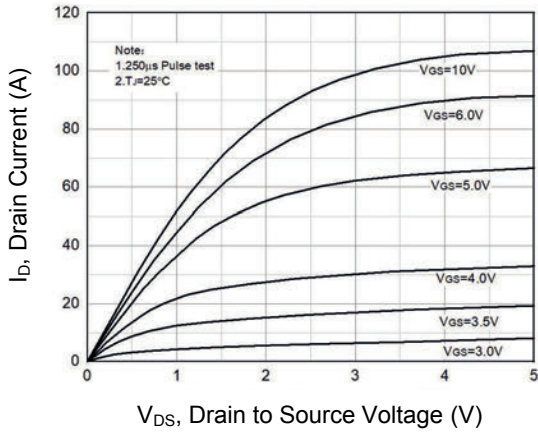
### Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise specified)

| Parameter                                       | Symbol                | Conditions                                                                                 | Min. | Typ. | Max. | Unit |
|-------------------------------------------------|-----------------------|--------------------------------------------------------------------------------------------|------|------|------|------|
| <b>On / Off Characteristics</b>                 |                       |                                                                                            |      |      |      |      |
| Drain-to-Source Breakdown Voltage               | V <sub>(BR)DSS</sub>  | V <sub>GS</sub> =0V, I <sub>D</sub> =250μA                                                 | 100  | -    | -    | V    |
| Drain-to-Source Leakage Current                 | I <sub>DSS</sub>      | V <sub>DS</sub> =100V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C                           | -    | -    | 1.0  | μA   |
|                                                 |                       | V <sub>DS</sub> =100V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C                          | -    | 1.2  | -    |      |
| Gate-to-Source Forward Leakage                  | I <sub>GSS</sub>      | V <sub>DS</sub> =0V, V <sub>GS</sub> =20V                                                  | -    | -    | 100  | nA   |
|                                                 |                       | V <sub>DS</sub> =0V, V <sub>GS</sub> =-20V                                                 | -    | -    | -100 |      |
| Static Drain-to-Source On-Resistance            | R <sub>DS(ON)</sub>   | V <sub>GS</sub> =10V, I <sub>D</sub> =10A                                                  | -    | 26   | 34   | mΩ   |
| Gate Threshold Voltage                          | V <sub>GS(th)</sub>   | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA                                   | 1.1  | -    | 2.8  | V    |
| <b>Dynamic and Switching Characteristics</b>    |                       |                                                                                            |      |      |      |      |
| Input Capacitance                               | C <sub>iss</sub>      | V <sub>GS</sub> =0V, V <sub>DS</sub> =50V, f=1MHz                                          | -    | 1051 | -    | pF   |
| Output Capacitance                              | C <sub>oss</sub>      |                                                                                            | -    | 130  | -    |      |
| Reverse Transfer Capacitance                    | C <sub>rss</sub>      |                                                                                            | -    | 3.8  | -    |      |
| Total Gate Charge <sup>4,5</sup>                | Q <sub>g</sub>        | I <sub>D</sub> =10A, V <sub>DD</sub> =50V, V <sub>GS</sub> =10V                            | -    | 16   | -    | nC   |
| Gate-to-Source Charge <sup>4,5</sup>            | Q <sub>gs</sub>       |                                                                                            | -    | 4.1  | -    |      |
| Gate-to-Drain ("Miller") Charge <sup>4,5</sup>  | Q <sub>gd</sub>       |                                                                                            | -    | 3.7  | -    |      |
| Gate Plateau <sup>4,5</sup>                     | V <sub>plateau</sub>  |                                                                                            | -    | 4.0  | -    | V    |
| Turn-On Delay Time <sup>4,5</sup>               | t <sub>d(on)</sub>    | V <sub>DD</sub> =50V, V <sub>GS</sub> =10V, R <sub>G</sub> =1.6Ω, I <sub>D</sub> =10A      | -    | 6.4  | -    | nS   |
| Rise Time <sup>4,5</sup>                        | t <sub>r</sub>        |                                                                                            | -    | 30   | -    |      |
| Turn-Off Delay Time <sup>4,5</sup>              | t <sub>d(off)</sub>   |                                                                                            | -    | 21   | -    |      |
| Fall Time <sup>4,5</sup>                        | t <sub>f</sub>        |                                                                                            | -    | 9.4  | -    |      |
| Gate Resistance                                 | R <sub>g</sub>        | f=1MHz                                                                                     | -    | 1.9  | -    | Ω    |
| <b>Source-Drain Ratings and Characteristics</b> |                       |                                                                                            |      |      |      |      |
| Continuous Source Current (Body Diode)          | I <sub>S</sub>        | MOSFET symbol showing the integral reverse p-n junction diode.                             | -    | -    | 20   | A    |
| Diode Pulse Current                             | I <sub>S, pulse</sub> |                                                                                            | -    | -    | 80   | A    |
| Diode Forward Voltage                           | V <sub>SD</sub>       | I <sub>S</sub> =10A, V <sub>GS</sub> =0V                                                   | -    | -    | 1.4  | V    |
| Reverse Recovery Time <sup>4</sup>              | T <sub>rr</sub>       | I <sub>S</sub> =10A, V <sub>GS</sub> =0V, V <sub>R</sub> =50V, dI <sub>F</sub> /dt=100A/μs | -    | 34   | -    | nS   |
| Reverse Recovery Charge <sup>4</sup>            | Q <sub>rr</sub>       |                                                                                            | -    | 37   | -    | nC   |

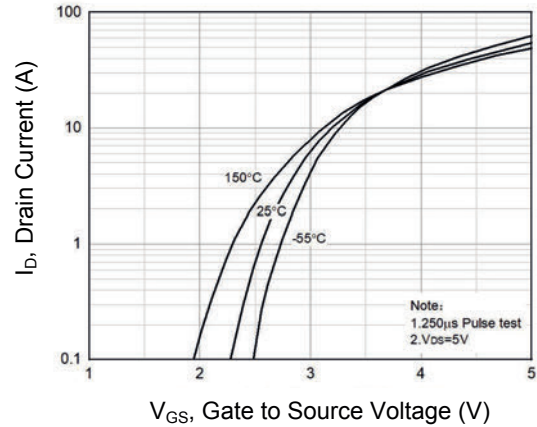
#### Notes

- The rated value only refers to the maximum absolute value under 25°C shell temperature in the manual.  
If the shell temperature is higher than 25°C, the rating shall be reduced according to the actual environmental conditions.
- Pulse time 5μs and the pulse width is limited to the maximum junction temperature.
- The value of dissipated power will change with the temperature. When the temperature is higher than 25°C, the value of dissipated power will decrease by 0.04W/°C with each temperature rise of 1°C.
- Pulse test : pulse width ≤ 300μs, duty cycle ≤ 2%.
- Essentially independent of operating temperature.

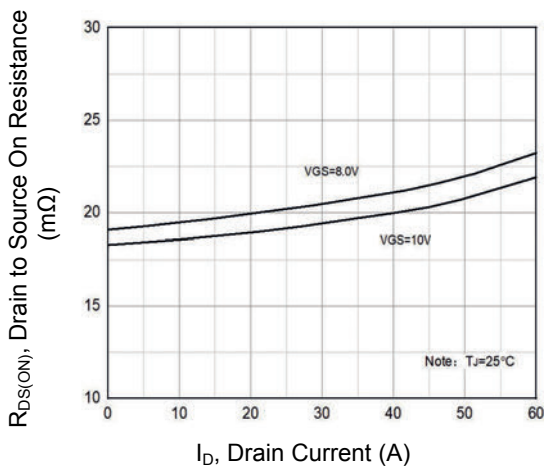
### Typical Electrical and Thermal Characteristic Curves



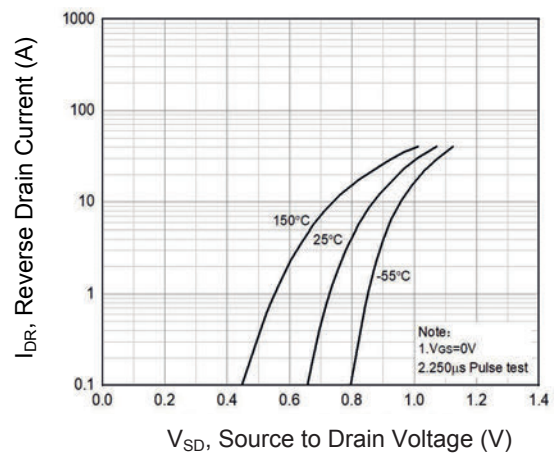
**Figure 1. Typical Output Characteristics**



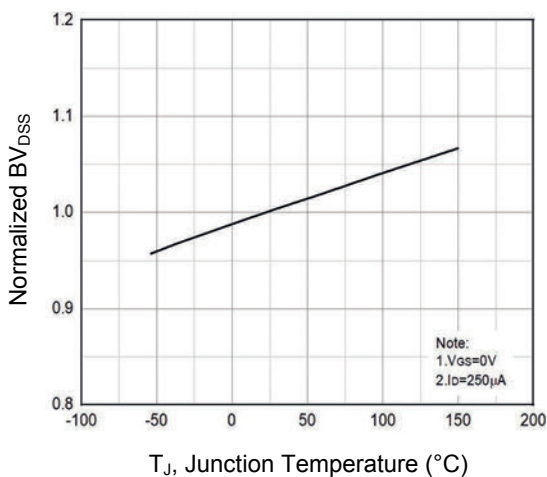
**Figure 2. Transfer Characteristics**



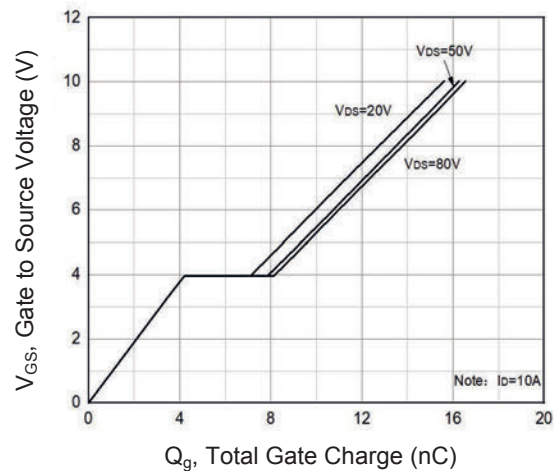
**Figure 3.  $R_{DS(ON)}$  Vs. Drain Current**



**Figure 4. Body Diode Characteristics**

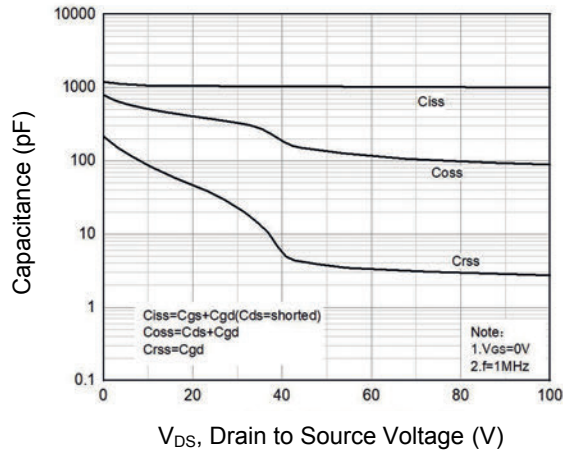


**Figure 5. Normalized  $BV_{DSS}$  Vs.  $T_J$**

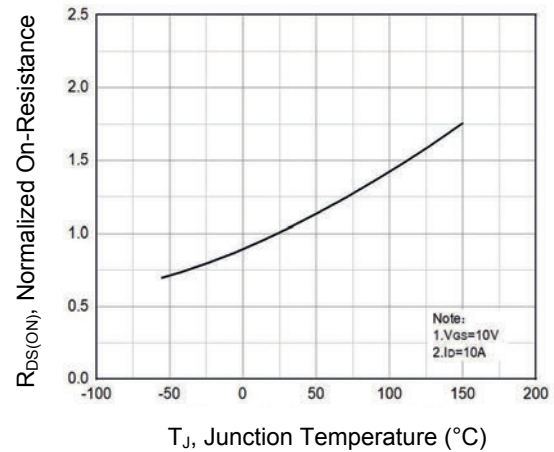


**Figure 6. Gate Charge**

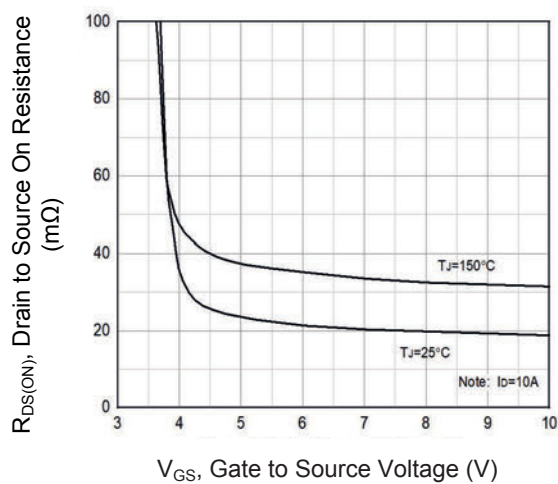
## Typical Electrical and Thermal Characteristic Curves



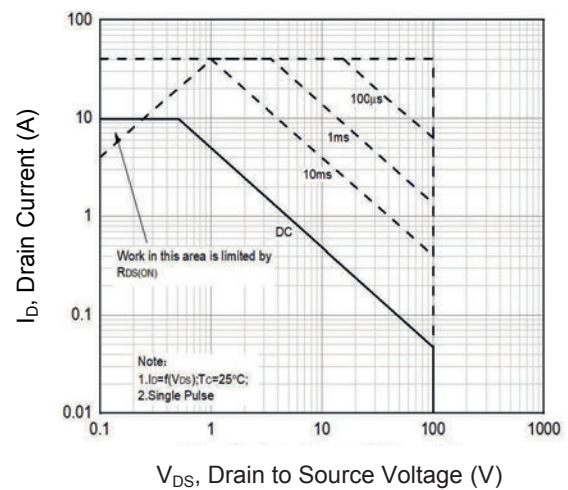
**Figure 7. Capacitance Characteristics**



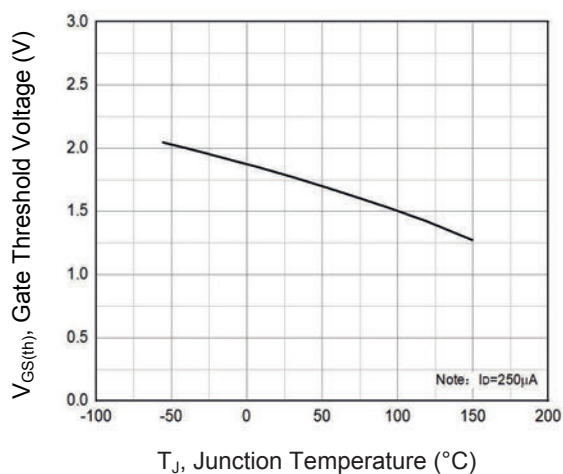
**Figure 8. Normalized  $R_{DS(ON)}$  Vs.  $T_J$**



**Figure 9. Normalized  $R_{DS(ON)}$  Vs.  $V_{GS}$**

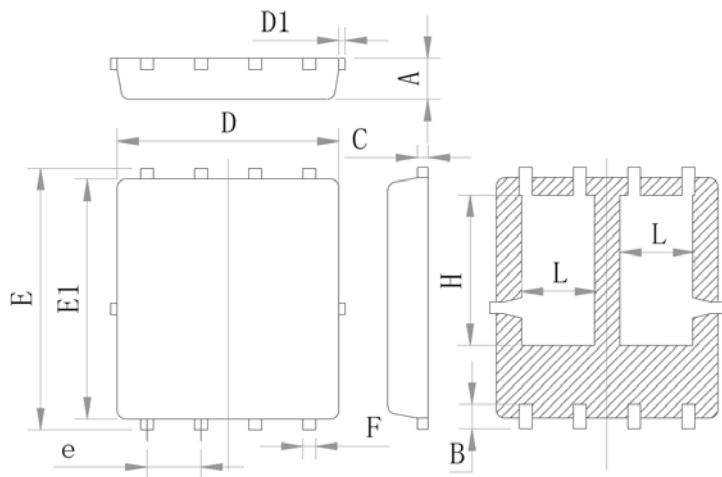


**Figure 10. Safe Operation Area**



**Figure 11. Gate Threshold Voltage Vs.  $T_J$**

## Package Outline Dimensions (PPAK5x6)



| Symbol | Dimensions In Millimeters |      | Dimensions In Inches |       |
|--------|---------------------------|------|----------------------|-------|
|        | Min.                      | Max. | Min.                 | Max.  |
| A      | 0.90                      | 1.00 | 0.035                | 0.039 |
| B      | 0.48                      | 0.68 | 0.019                | 0.027 |
| C      | 0.20                      | 0.30 | 0.008                | 0.012 |
| D      | 5.00                      | 5.40 | 0.197                | 0.213 |
| D1     | -                         | 0.15 | -                    | 0.006 |
| E      | 5.90                      | 6.20 | 0.232                | 0.244 |
| E1     | 5.60                      | 6.00 | 0.220                | 0.236 |
| e      | 1.22                      | 1.32 | 0.048                | 0.052 |
| F      | 0.25                      | 0.35 | 0.010                | 0.014 |
| H      | 3.27                      | 3.67 | 0.129                | 0.144 |
| L      | 1.50                      | 1.90 | 0.059                | 0.075 |